

PUBLISHER'S SWORN STATEMENT



Publisher's Sworn Statement

Advanced Materials & Processes® is published monthly and is the official publication of ASM International which has been serving its members for more than 100 years.

Advanced Materials & Processes®

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Field Served

As of August 2014, ASM had 26,230 members that are metallurgists, engineers, scientists, researchers, teachers, and students. Our members work primarily with metals but also with structural polymers, ceramics, and composites. ASM members develop materials and also specify materials so that aircraft, automobiles, buildings, bridges, medical devices...just about anything...are strong enough, light enough, and affordable enough to serve their intended purpose. Members apply their skills and knowledge in the design, manufacture, and testing of materials.

Circulation

While not all members receive *AM&P*, the magazine has an average distribution of 13,000 mailed copies per month with an average number of 2 readers per issue (the subscriber + 1 pass along reader), per Signet 2014 readership studies. *AM&P* has a **total potential reading audience of nearly 26,000**.

AM&P has a circulation of approximately 11,000 copies in the United States, 1,000 copies to Canada, and 550 copies to Europe and the Pacific Rim.

AM&P is also produced as a Digital Edition with more than 16,000 subscribers.

Statement of the Ownership, Management, Circulation, etc.

Required by the Act of 23 October 1962, Section 4369, Title 39, United States Code, showing the ownership, management, and circulation of *Advanced Materials & Processes*®, published monthly, except bimonthly November/December, at Materials Park, Ohio, for September 2014.

1. The names and addresses of the publisher and editor are: Scott D. Henry and Frances Richards, respectively, both of 9639 Kinsman Road, Materials Park, Ohio.
2. The owner is ASM International®, Materials Park, Ohio, which is a not-for-profit educational institution, the officers being; President and Trustee, C. Ravi Ravindran; Vice President and Trustee, Sunniva R. Collins; Secretary and Managing Director, Thomas S. Passek; Treasurer and Trustee, Robert J. Fulton; Immediate Past President and Trustee, Gernant E. Maurer; Trustees, Jeffrey A. Hawk, William J. Lenling, Linda S. Schadler, Iver Anderson, Mitchell Dorfman, James C. Foley, Jacqueline M. Earle, John R. Keough, and Zi-Kui Liu; Student Board Members Virginia K. Judge, Anthony Lombardi, and Myrissa N. Maxfield.
There are no known bondholders, mortgagees, and other security holders owning or holding 1% or more of the total amount of bonds, mortgages, or other securities.
3. The known bondholders, mortgagees, and other security holders owning or holding 1% or more of the total amount of bonds, mortgages, or other securities are: None.
4. Paragraphs 2 and 3 include, in cases where the stockholder or security holder appears upon the books of the company as trustee or in any other fiduciary relation, the name of the person or corporation for whom such trustee is acting. Also, the statements in the two paragraphs show the affiant's full knowledge and belief as to the circumstances and conditions under which stockholders and security holders who do not appear upon the books of the company as trustees, hold stock and securities in a capacity other than that of a bona fide owner.
5. The average number of copies of each issue of this publication sold or distributed through the mails, or otherwise, to paid subscribers during the 12 months preceding the date shown above was 13,168 plus free distribution (including samples) by mail, carrier delivery, or by other means, 1,184, for a total of 14,352 copies distributed. Average total number of copies printed (net press run): 14,381.

I certify that the information in this Publisher's Statement is correct.

A handwritten signature in black ink that reads "Scott D. Henry".

Scott D. Henry
Publisher

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